Din-Tek

SEMICONDUCTOR

| PRODUCT SUMMARY | | | | | | | |
|---------------------|--------------------------------|---------------------|-----------------------|--|--|--|--|
| V _{DS} (V) | R _{DS(on)} (mΩ)(Typ.) | I _D (A)ª | Q _g (Typ.) | | | | |
| 150 | 5.9 at V _{GS} = 10 V | 119 | 75 nC | | | | |

TO-220 Pin Configuration Top View

D

N-Channel 150 V (D-S) MOSFET

FEATURES

- DT-SGT Power MOSFET
- · Very Low On-resistance
- 100% ΔVDS & UIS & Rg Tested

APPLICATIONS

- DC-DC Converter
- · Uninterruptible Power Supply
- · Power Switching Application

| 6 |
|------------------|
| S |
| N-Channel MOSFET |

| ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted) | | | | | | | |
|---|-----------------------------------|------------------|------|---|--|--|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | | | |
| Drain-Source Voltage | V _{DS} | 150 | V | | | | |
| Gate-Source Voltage | V _{GS} | ± 20 | V | | | | |
| | T _C = 25 °C | | 119 | | | | |
| Continuous Drain Current $(T_J = 150 \text{ °C})^a$ | T _C = 100 °C | – I _D | 75 | А | | | |
| Pulsed Drain Current ^b | I _{DM} | 476 | | | | | |
| Single Avalanche Energy | E _{AS} | 380 | mJ | | | | |
| Maximum Bawar Dissinctions | T _C = 25 °C | D | 208 | w | | | |
| Maximum Power Dissipation ^c | T _C = 100 °C | P _D | 83 | v | | | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | -55 to +150 | °C | | | | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|--|-------------------|-----|------|--|--|--|--|
| PARAMETER | SYMBOL LIMIT | | UNIT | | | | |
| Junction-to-Ambient (PCB Mount) ^d | R _{thJA} | 33 | °C/W | | | | |
| Junction-to-Case (Drain) | R _{thJC} | 0.6 | 0/10 | | | | |

Notes

a. Calculated continuous current based on maximum allowablejunction temperature.

- b. Repetitive rating; pulse width limited by max. junction temperature.
- c. Pd is based on max. junction temperature, using junction-case thermal resistance.
- d. The value of R_{0JA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with Ta=25 °C.



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| SPECIFICATIONS (T _C = 25 °C, unless otherwise noted) | | | | | | | | |
|---|---------------------|--|------|------|-------|------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | | |
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 150 | - | - | V | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 2 | - | 4 | v | | |
| Gate-Body Leakage | I _{GSS} | V_{DS} = 0 V, V_{GS} = ± 20 V | - | - | ± 100 | nA | | |
| Zero Gate Voltage Drain Current | | $V_{DS} = 150 V, V_{GS} = 0 V$ | - | - | 1 | μA | | |
| Zelo Gale Voltage Drain Gurrent | IDSS | V_{DS} = 120 V, V_{GS} = 0 V, T_{J} = 150 °C | - | - | 100 | | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 119 | - | - | А | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 50 A | - | 5.9 | 6.9 | mΩ | | |
| Dynamic ^b | | | | | | | | |
| Input Capacitance | C _{iss} | | - | 6280 | - | | | |
| Output Capacitance | C _{oss} | V_{GS} = 0 V, V_{DS} = 75 V, f = 1 MHz | - | 470 | - | pF | | |
| Reverse Transfer Capacitance | C _{rss} | | - | 9 | - | | | |
| Total Gate Charge ^c | Qg | | | 75 | - | | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$ | - | 25.3 | - | nC | | |
| Gate-Drain Charge ^c | Q _{gd} | | - | 12.5 | - | | | |
| Gate Resistance | Rg | f = 1 MHz | - | 0.6 | - | Ω | | |
| Turn-On Delay Time ^c | t _{d(on)} | | - | 4.4 | - | | | |
| Rise Time ^c | t _r | $V_{DD} = 75 \text{ V}, \text{ R}_{GEN} = 2.7 \Omega, I_D = 50 \text{ A},$ | - | 24.6 | - | ns | | |
| Turn-Off Delay Time ^c | t _{d(off)} | V _G s = 10 V | - | 38.1 | - | | | |
| Fall Time ^c | t _f | | - | 9.5 | - | | | |
| Drain-Source Body Diode Ratings and Characteristics ^b ($T_c = 25 \ ^{\circ}C$) | | | | | | | | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | - | - | 119 | А | | |
| Pulsed Current | I _{SM} | | - | - | 476 | A | | |
| Forward Voltage ^a | V _{SD} | $I_{F} = 50 \text{ A}, V_{GS} = 0 \text{ V}$ | - | 0.86 | 1.2 | V | | |
| Reverse Recovery Time | t _{rr} | L = 50 A di/dt = 100 A/iso | - | 97.4 | - | ns | | |
| Reverse Recovery Charge | Q _{rr} | I _F = 50 A, di/dt = 100 A/µs | - | 217 | - | nC | | |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those in dicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Ti=25°C

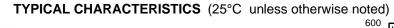
Tj=150°0

VDS=10V

Vgs-Gate to Source Voltage (V)

Figure 2. Transfer Characteristics; typical values

ID-Drain Current (A)



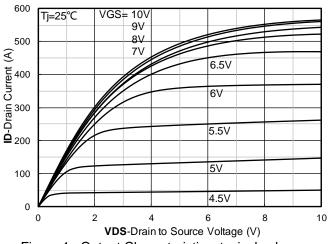
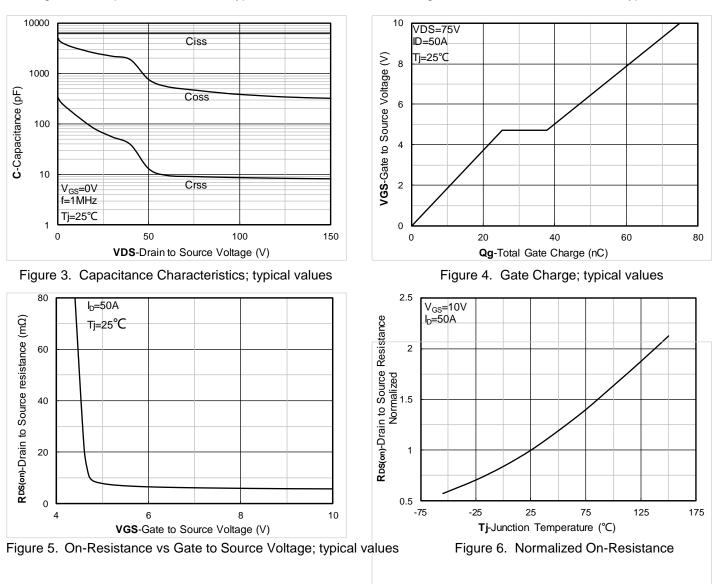
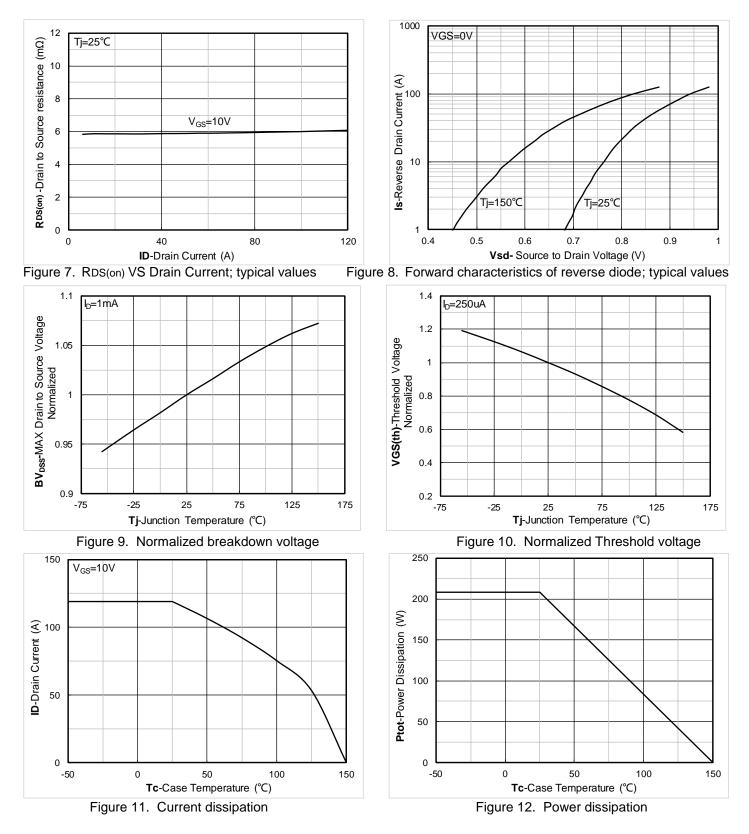


Figure 1. Output Characteristics; typical values





TYPICAL CHARACTERISTICS (25°C unless otherwise noted)





TYPICAL CHARACTERISTICS (25°C unless otherwise noted)

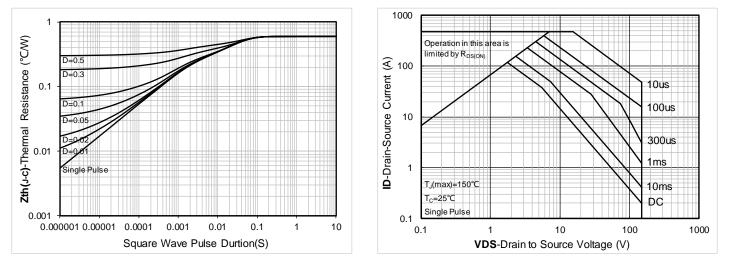


Figure 13. Maximum Transient Thermal Impedance

Figure 14. Safe Operation Area



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Test Circuits & Waveforms

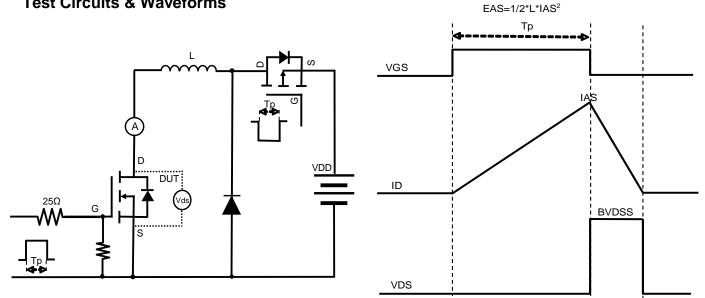


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

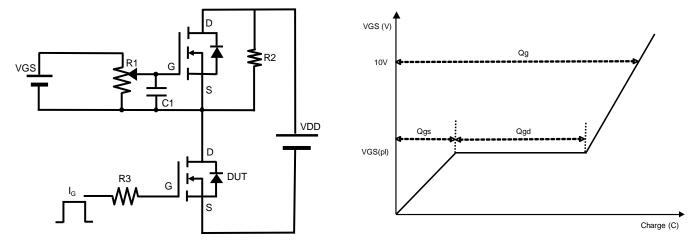


Figure B. Gate Charge Test Circuit & Waveform

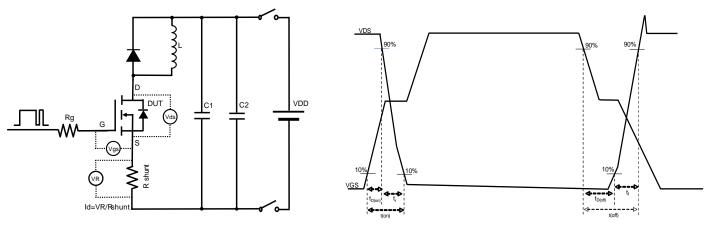


Figure C. Resistive Switching Test Circuit & Waveform



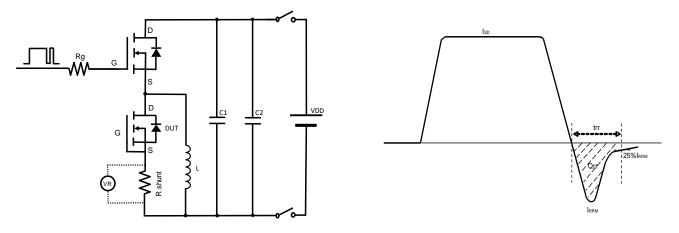
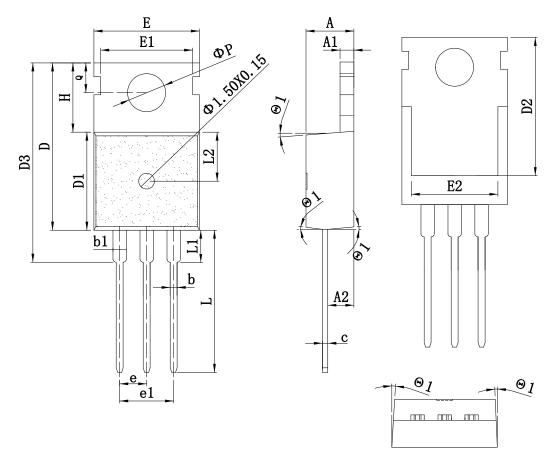


Figure D. Diode Recovery Test Circuit & Waveform



TO-220_3L-A PACKAGE OUTLINE

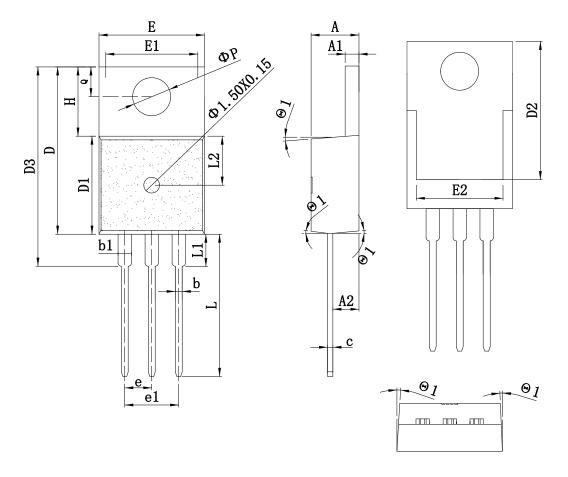


COMMON DIMENSIONS (UNITS OF MEASURE= MILLIMETER)

| SYMBOL | mm | | | SYMBOL | mm | | | |
|--------|-------|-------|-------|----------|---------|-------|-------|--|
| | MIN | TYP | MAX | STIVIDUL | MIN | TYP | MAX | |
| A | 4.15 | 4.50 | 4.80 | E1 | 8.25 | 8.70 | 9.15 | |
| A1 | 1.15 | 1.30 | 1.50 | E2 | 7.20 | 8.00 | 8.80 | |
| A2 | 2.10 | 2.40 | 2.65 | е | 2.38 | 2.54 | 2.74 | |
| b | 0.65 | 0.80 | 1.00 | e1 | 5.08REF | | | |
| b1 | 1.10 | 1.33 | 1.80 | Н | 6.20 | 6.50 | 6.90 | |
| С | 0.35 | 0.50 | 0.65 | L | 12.75 | 13.28 | 13.70 | |
| D | 14.25 | 15.75 | 16.15 | L1 | - | - | 3.50 | |
| D1 | 8.70 | 9.20 | 9.60 | L2 | 2.30 | 4.65 | 7.00 | |
| D2 | 12.30 | 13.10 | 13.85 | φP | 3.40 | 3.65 | 3.85 | |
| D3 | 16.20 | 18.80 | 20.60 | Q | 2.50 | 2.80 | 3.00 | |
| E | 8.68 | 10.02 | 11.00 | θ | 2° | - | 7° | |



TO-220_3L-B PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE= MILLIMETER)

| SYMBOL | mm | | | SYMBOL | mm | | | |
|--------|-------|-------|-------|----------|---------|-------|-------|--|
| | MIN | TYP | MAX | STIVIDUL | MIN | TYP | MAX | |
| А | 4.15 | 4.50 | 4.80 | E1 | 8.25 | 8.70 | 9.15 | |
| A1 | 1.15 | 1.30 | 1.50 | E2 | 7.20 | 8.00 | 8.80 | |
| A2 | 2.10 | 2.40 | 2.65 | е | 2.38 | 2.54 | 2.74 | |
| b | 0.65 | 0.80 | 1.00 | e1 | 5.08REF | | | |
| b1 | 1.10 | 1.33 | 1.80 | Н | 6.20 | 6.50 | 6.90 | |
| С | 0.35 | 0.50 | 0.65 | L | 12.75 | 13.28 | 13.70 | |
| D | 14.25 | 15.75 | 16.15 | L1 | - | - | 3.50 | |
| D1 | 8.70 | 9.20 | 9.60 | L2 | 2.30 | 4.65 | 7.00 | |
| D2 | 12.30 | 13.10 | 13.85 | φP | 3.40 | 3.65 | 3.85 | |
| D3 | 16.20 | 18.80 | 20.60 | Q | 2.50 | 2.80 | 3.00 | |
| E | 8.68 | 10.02 | 11.00 | θ | 2° | - | 7° | |



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